

Application Data Sheet**Applicant Information**

Applicant Authority type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Sadayoshi
Family Name:: HORII
City of Residence:: Nakano-ku
Country of Residence:: JAPAN

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hironobu
Family Name:: MIYA
City of Residence:: Nakano-ku
Country of Residence:: JAPAN

Correspondence Information

Correspondence Customer Number::

25944

Application Information

Application Type:: National Phase
Subject Matter:: Utility
CD-ROM or CD-R:: None
Title:: MANUFACTURING METHOD OF
SEMICONDUCTOR DEVICE AND
SUBSTRATE PROCESSING APPARATUS
Attorney Docket Number:: 123373
Suggested Drawing Figure::
Total Drawing Sheets:: 11
Small Entity:: No

Representative Information

Attorneys associated with Customer No. 25944.

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/013606	10/24/03
Foreign Priority Information			
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2002-316154	10/30/2002	Yes
Assignee Information			
Assignee Name::		HITACHI KOKUSAI ELECTRIC, INC.	
Street of mailing address::		14-20, Higashi-Nakano 3-chome,	
City of mailing address::		Nakano-ku,	
State or Province of mailing address::		Tokyo,	
Country of mailing address::		JAPAN	
Postal or Zip Code of mailing address::		164-8511	